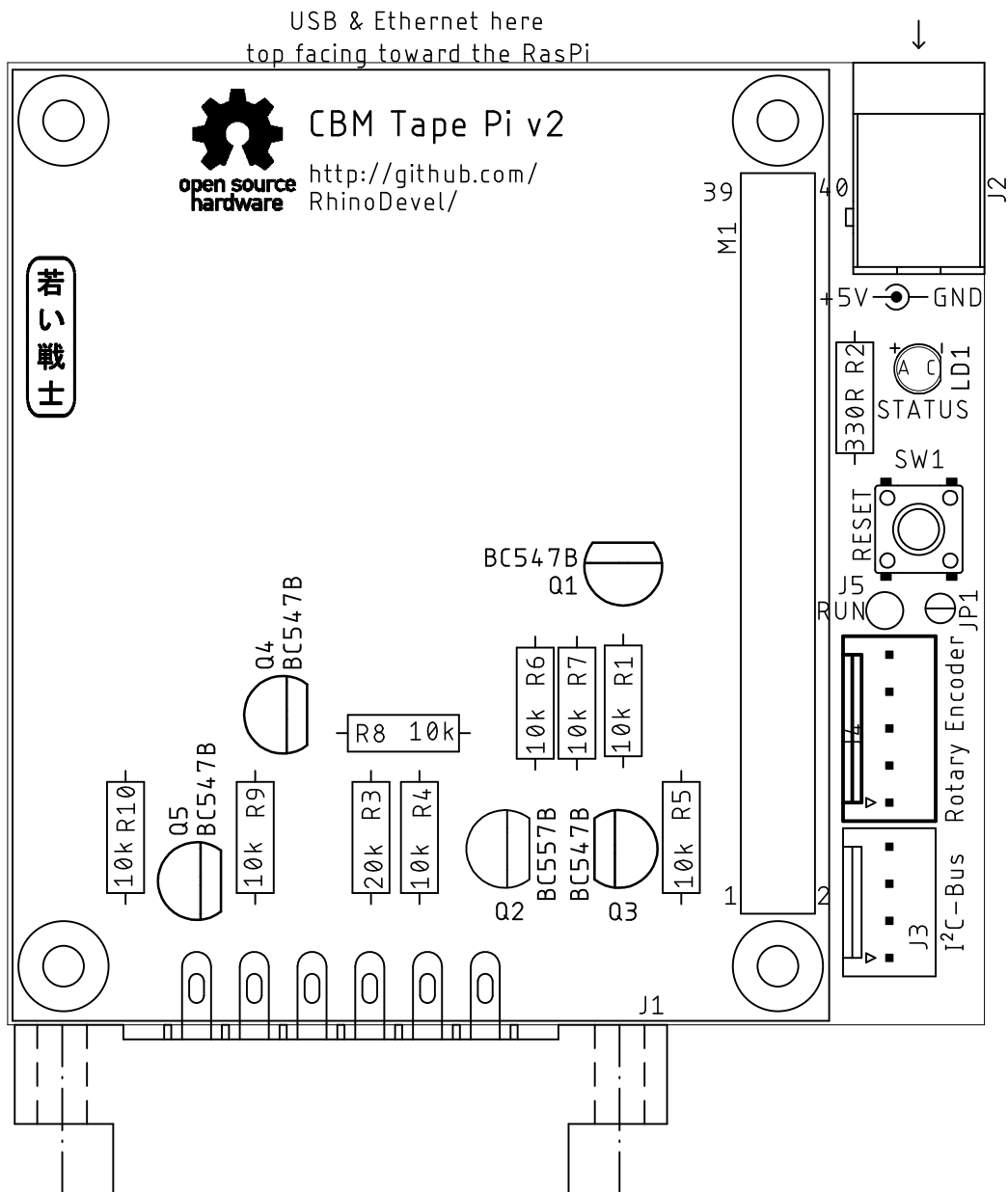


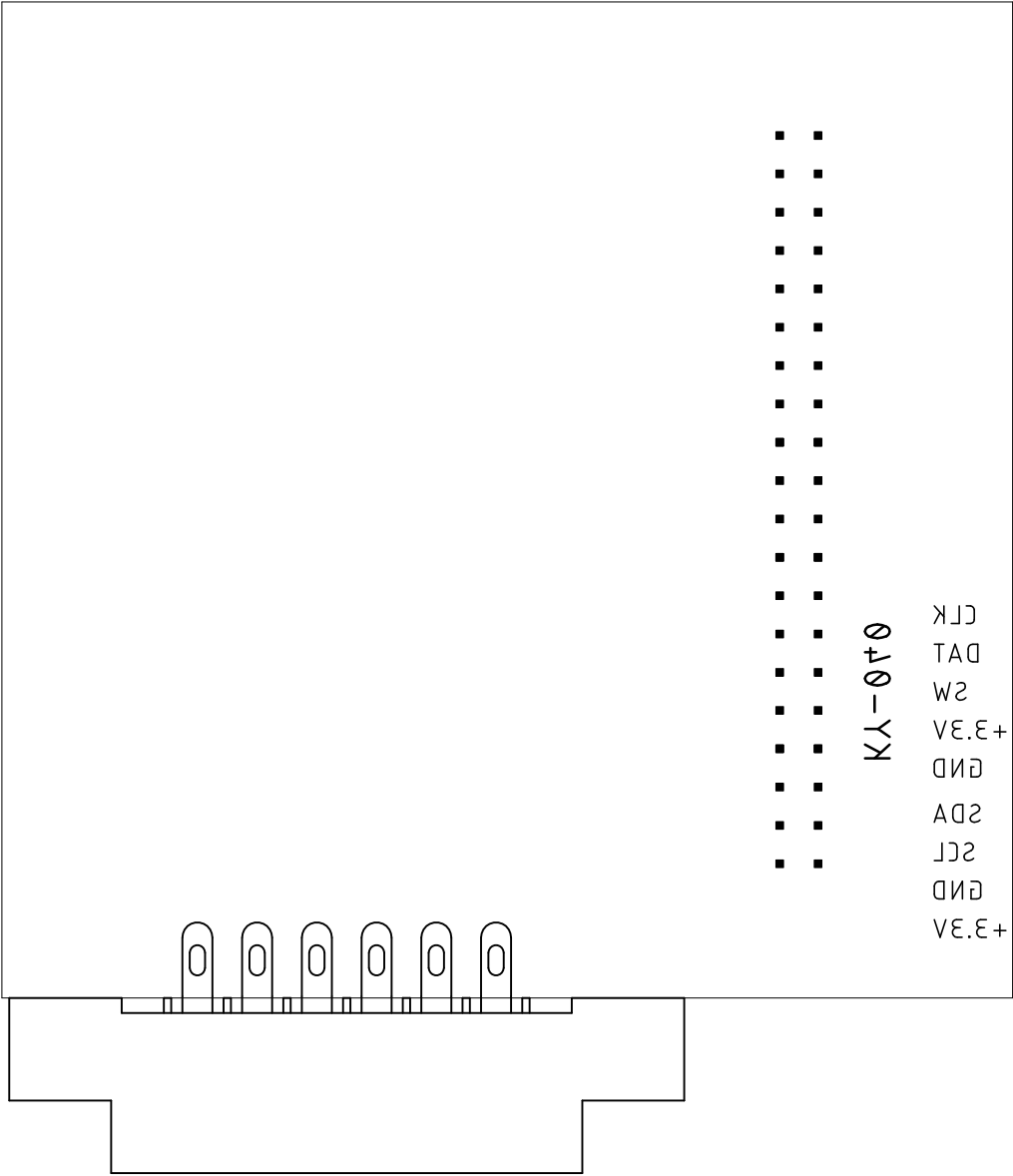


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	Marcel Timm	<b>Draft:</b>	Sven Petersen
<b>Date:</b>	29.04.2021	<b>Rev:</b>	2
<b>File:</b>	CBM_TAPE_Pi	<b>Page</b>	1/1

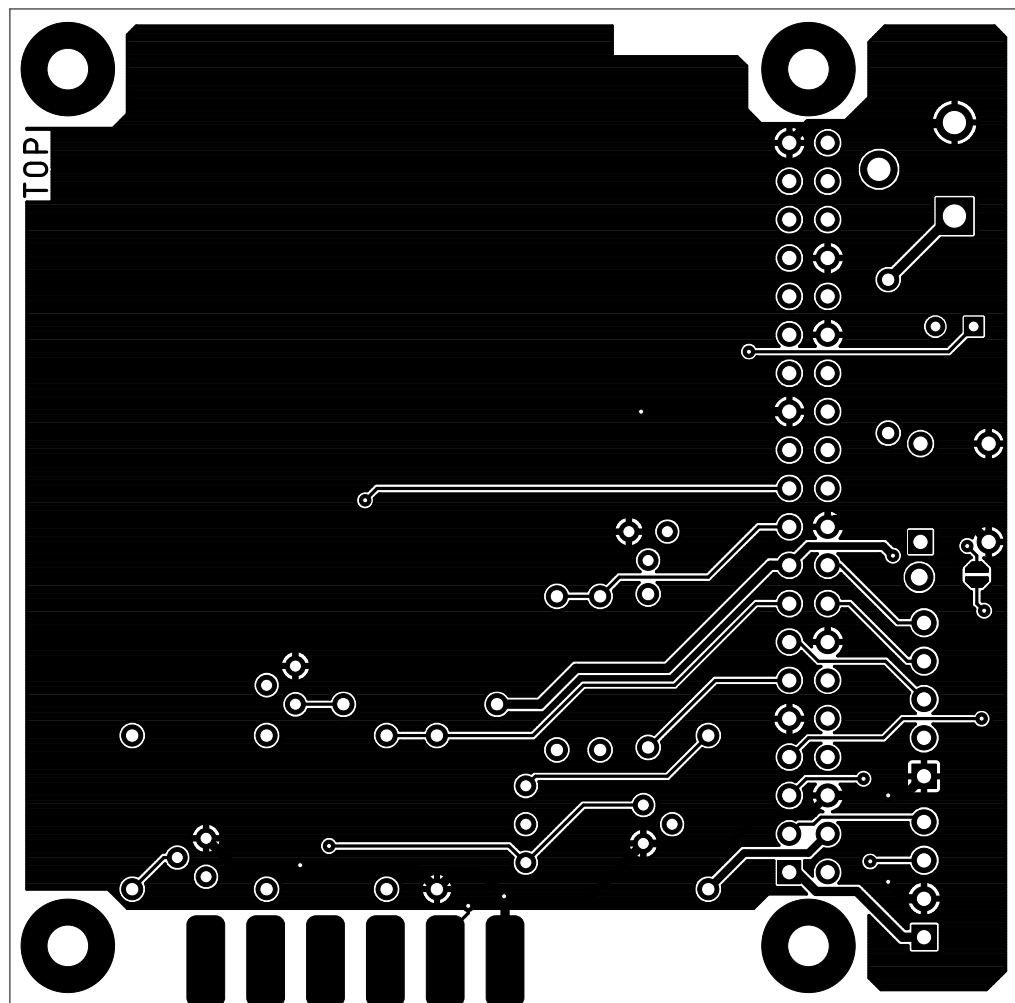
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CBM_TAPE_PI		
01.05.2021 17:45		Rev.: 2
placement component side		



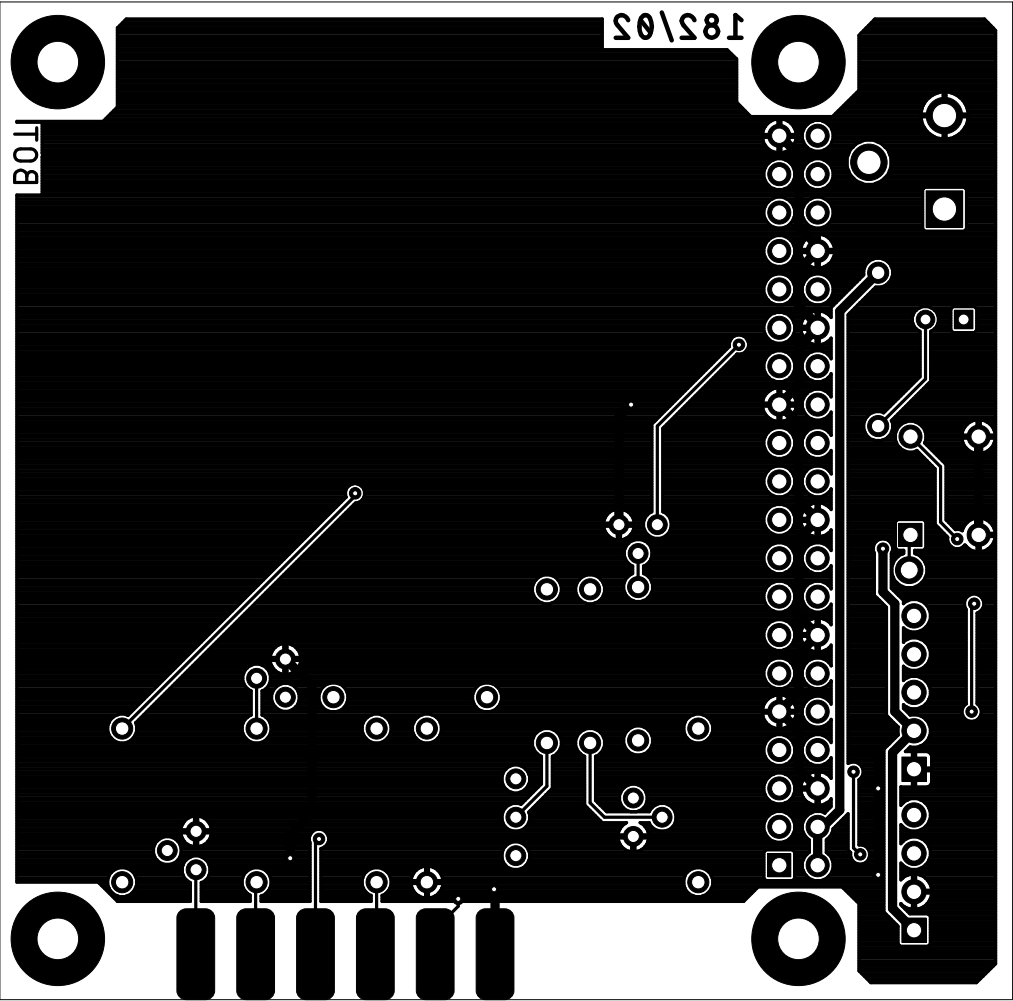
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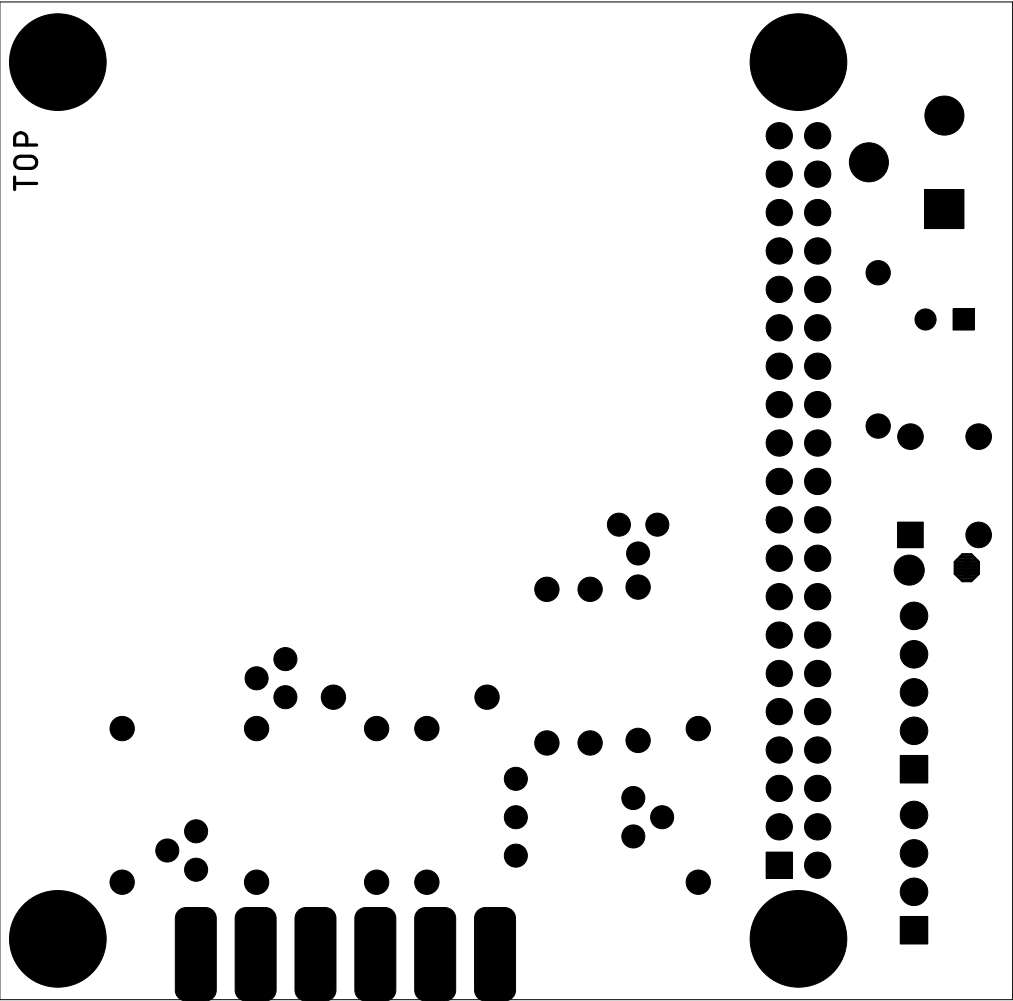
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top		



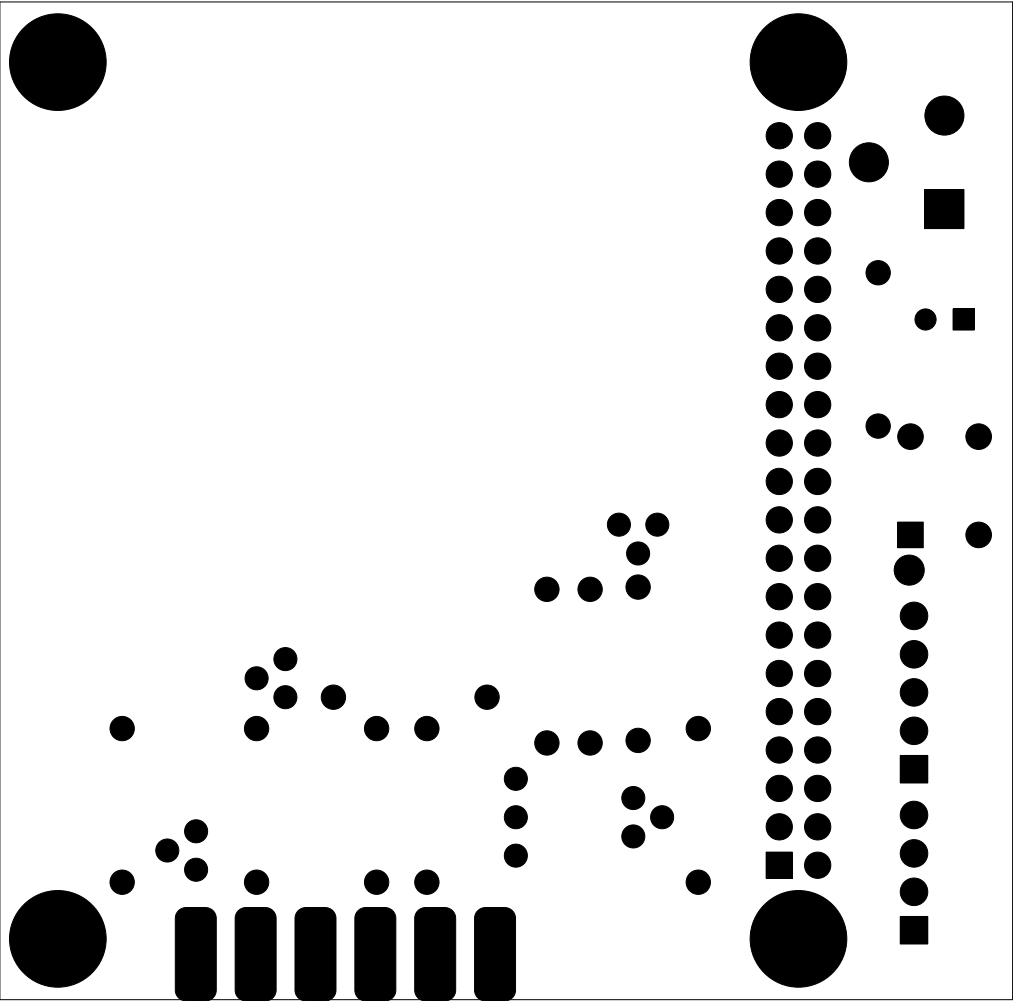
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29.04.2021 16:20		Rev.: 2
bottom		



Marcel Timm 2021	Doc.-No.: 182-2-01-02	
	Cu: 35µm	Cu-Layers:
CBM_TAPE_PI		
29.04.2021 16:20		Rev.: 2
stopmask component side		



Marcel Timm 2021	Doc.-No.: 182-2-01-02	
	Cu: 35µm	Cu-Layers:
CBM_TAPE_PI		
29.04.2021 16:20		Rev.: 2
stopmask solder side		



Marcel Timm 2021	Doc.-No.: 182-2-01-02	
	Cu: 35µm	Cu-Layers:
CBM_TAPE_PI		
01.05.2021 17:45		Rev.: 2
placement component side		measures

